

Delft University of Technology

Author Correction: A doping-less junction-formation mechanism between n-silicon and an atomically thin boron layer (Scientific Reports, (2017), 7, 1, (13247), 10.1038/s41598-017-13100-0)

Mohammadi, Vahid; Nihtianov, Stoyan; Fang, Changming

DOI 10.1038/s41598-021-99821-9

Publication date 2021

Document Version Final published version

Published in Scientific Reports

Citation (APA)

Mohammadi, V., Nihtianov, S., & Fang, C. (2021). Author Correction: A doping-less junction-formation mechanism between n-silicon and an atomically thin boron layer (Scientific Reports, (2017), 7, 1, (13247), 10.1038/s41598-017-13100-0). *Scientific Reports*, *11*(1), Article 20579. https://doi.org/10.1038/s41598-021-99821-9

Important note

To cite this publication, please use the final published version (if applicable). Please check the document version above.

Copyright

Other than for strictly personal use, it is not permitted to download, forward or distribute the text or part of it, without the consent of the author(s) and/or copyright holder(s), unless the work is under an open content license such as Creative Commons.

Takedown policy

Please contact us and provide details if you believe this document breaches copyrights. We will remove access to the work immediately and investigate your claim.

scientific reports

Published online: 12 October 2021

Check for updates **OPEN** Author Correction: A doping-less junction-formation mechanism between n-silicon and an atomically thin boron layer

Vahid Mohammadi, Stoyan Nihtianov & Changming Fang

Correction to: Scientific Reports https://doi.org/10.1038/s41598-017-13100-0, published online 16 October 2017

Whilst the original version of this Article cited Mohammadi's related thesis as reference 2, the relevant original literature covering the technological aspects were not. As a result, references 32 - 35 are omitted and are listed below.

- 32. Mok, K.R.C., Mohammadi, V., Nanver, L.K., de Boer, W.D., & Vlooswijk, A.H.G. Low-pressure chemical vapor deposition of PureB layers on silicon for p+n junction formation. In 12th International Workshop on Junction Technology, Shanghai, China, 113-116 https://doi.org/10.1109/IWJT.2012.6212822, 113-116 (2012).
- 33. Nanver, L.K. et al. Pure dopant deposition of B and Ga for ultra-shallow junctions in Si-based devices. ECS Trans. 49, 25 (2012).
- 34. Mohammadi, V. et al. VUV/low-energy-electron Si photodiodes with post-metal 400 °C PureB deposition. IEEE Electron. Device Lett. 34, 1545 (2013) DOI:https://doi.org/10.1109/LED.2013.2287221 (2013).
- 35. Nanver, L.K. et al. Robust UV/VUV/EUV PureB photodiode detector technology with high CMOS compatibility. IEEE J. Sel. Top. Quantum Electron. 20, 306-316. DOI:https://doi.org/10.1109/JSTQE.2014.23195 82i (2014).

In addition, reference 36, which discusses an alternative junction formation mechanism, was omitted and is listed below.

Qi, L. and Nanver, L.K. Conductance along the interface formed by 400 °C pure boron deposition on 36. silicon. IEEE Electron. Device Lett. 36, 15102. DOI:https://doi.org/10.1109/LED.2014.2386296 (2015).

Consequently, the sentence in the Introduction,

"It has been shown that a nanometer-thin boron amorphous layer can be created on the surface of crystalline silicon through a chemical vapor deposition (CVD) process in the temperature range from 700 °C to 400 °C²."

should read:

"It has been shown that a nanometer-thin boron amorphous layer can be created on the surface of crystalline silicon through a chemical vapor deposition (CVD) process in the temperature range from 700 °C to 400 °C^{2,32–36}.

And the text,

"The as-formed rectifying junction exhibits excellent electrical and optical characteristics² without doping the silicon."

should read:

"The as-formed rectifying junction exhibits excellent electrical and optical characteristics^{2,36} without doping the silicon."

Finally, in the Methods section, under the subheading "Boron deposition on silicon", the sentence

"For the formation of the B-Si junction, some *ex-situ* and *in-situ* processing steps are necessary. The *ex-situ* steps involve removing oxides and contaminants at the Si surface and effectively passivating the surface ²."

should read:

"For the formation of the B-Si junction, some *ex-situ* and *in-situ* processing steps are necessary. The *ex-situ* steps involve removing oxides and contaminants at the Si surface and effectively passivating the surface^{2,32–35}."

References

- Mok, K. R. C., Mohammadi, V., Nanver, L. K., de Boer, W. D., & Vlooswijk, A. H. G. Low-pressure chemical vapor deposition of PureB layers on silicon for p+ n junction formation. In 12th International Workshop on Junction Technology, Shanghai, China, 113–116 https://doi.org/10.1109/IWJT.2012.6212822 (2012).
- 33. Nanver, L. K. et al. Pure dopant deposition of B and Ga for ultra-shallow junctions in Si-based devices. ECS Trans. 49, 25 (2012).
- Mohammadi, V. et al. VUV/low-energy-electron Si photodiodes with post-metal 400 °C PureB deposition. *IEEE Electron. Device Lett.* 34, 1545. https://doi.org/10.1109/LED.2013.2287221 (2013).
- Nanver, L. K. et al. Robust UV/VUV/EUV PureB photodiode detector technology with high CMOS compatibility. IEEE J. Sel. Top. Quantum Electron. 20, 306–316. https://doi.org/10.1109/JSTQE.2014.2319582i (2014).
- Qi, L. & Nanver, L. K. Conductance along the interface formed by 400 °C pure boron deposition on silicon. *IEEE Electron. Device* Lett. 36(15102) https://doi.org/10.1109/LED.2014.2386296 (2015).

Open Access This article is licensed under a Creative Commons Attribution 4.0 International License, which permits use, sharing, adaptation, distribution and reproduction in any medium or format, as long as you give appropriate credit to the original author(s) and the source, provide a link to the Creative Commons licence, and indicate if changes were made. The images or other third party material in this article are included in the article's Creative Commons licence, unless indicated otherwise in a credit line to the material. If material is not included in the article's Creative Commons licence and your intended use is not permitted by statutory regulation or exceeds the permitted use, you will need to obtain permission directly from the copyright holder. To view a copy of this licence, visit http://creativecommons.org/licenses/by/4.0/.

© The Author(s) 2021